ASSP For Screen Display Control

On-Screen Display Controller

MB90099

■ DESCRIPTION

The MB90099 is an on-screen display controller for displaying text and graphics on the TV screen. The three-channel output control function, compact package and low voltage operation make this device suitable for on-screen displays in portable devices including camera-integrated VTRs and digital still cameras.

The MB90099 controls a display area of 28 characters by 12 lines, and provides 1,024 different characters, each composed of 12×18 dots. All 1,024 characters in font ROM can be set by the user. The display functions include a wealth of characters with qualifying functions such as character background shading (shadow casting) and individual character size setting, with 16-color display selection for each character. Also included are the line background, screen background, and sprite character functions, providing a wide variety of screen display capabilities.

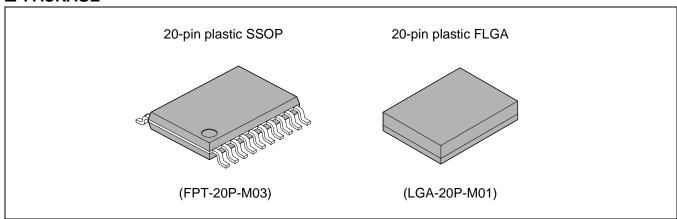
■ FEATURES

Character screen 28 characters × 12 lines (maximum) configuration :

• Character types: 1,024 characters (integrated in ROM, user definable through the entire area)

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■ PACKAGE





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• Font configuration : 12 × 18 dots (font ROM comfiguration)

Horizontal/vertical character display size setting enabled.

Two horizontal width settings (S/L) per character.

S size : 6 dots L size : 12 dots

Two vertical height settings (HA/HB) per line.

HA: 18 dots HB: 12 dots

• Display modes : Character trimming : Enabled/Disabled (set for each line)

Character background:

None/Solid-fill/Shaded background (concave) /Shaded background (convex)

(set for each character)

Horizontal character merge/independent display with shaded background (set for

each character)

Vertical line merge/independent display with shaded background (set for each line)

Character background display extended to line spacings: Enabled/Disabled (set

for

each line)

Line background:

None/Solid-fill/Shaded background (concave) /Shaded background (convex)

(set for each line)

(Display extends into left and right screen margins and into line spacings)

Character enlargement:

4 types: Normal, Double width, Double height, Double width x double height (set

for each line)

Enlarged character dot interpolation function (set for each line)

 Character screen display position control: Horizontal display position:

Control in 2-dot units (movable through the entire screen)

Vertical display position:

Control in 2-dot units (movable through the entire screen)

Line spacing control:

Control in 1-dot units (set between 0 to 7 dots for each line, applied simultaneously

to two areas above and below the line)

Sprite character control :

Sprite character display: Enable/Disabled

Sprite character types: 256 types (character codes 000H to 0FFH)

Sprite character trimming: Enabled/Disabled

Sprite character configuration: 2 types: 1 character/Stack of 2 characters

Sprite character horizontal display position: Control in 1-dot units (movable through

the entire screen)

Sprite character vertical display position : Control in 1-dot units (movable through

the entire screen)

Screen background

Screen background color: Enabled/Disabled

control:

• Display colors : Character color: 16 colors (set for each character)

Character trimming color: 16 colors (set for each line)

Character background color: 16 colors (set for each character) *

Line background color: 16 colors (set for each line)

Screen background color: 16 colors Sprite character color: 16 colors

Sprite character trimming color: 16 colors

Shaded background frame highlight color: 16 colors Shaded background frame shadow color: 16 colors

· Display signal Color signal output: 4 bits (supports 16 colors)

output: Display period signals: 3 channels (output selector circuit provided)

• External interface : 16-bit serial input:

Chip select Serial clock Serial data

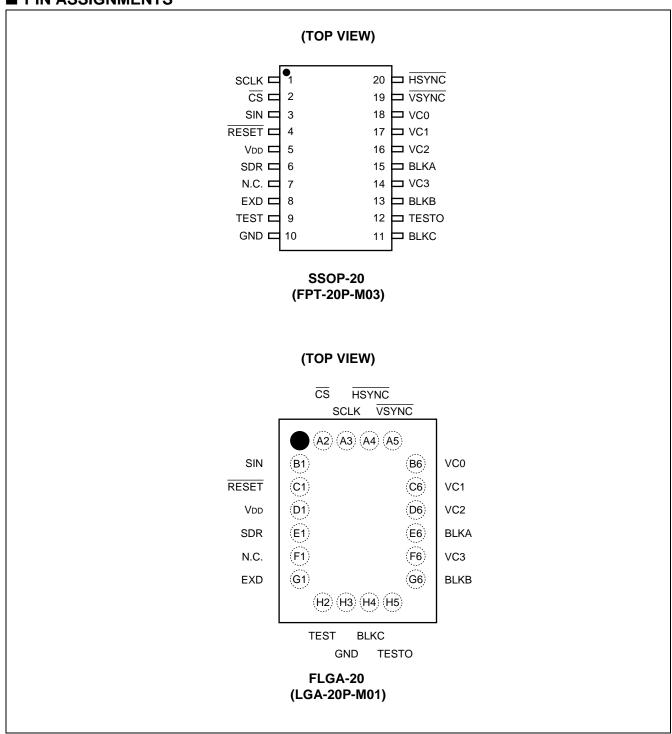
• Package: SSOP-20

FLGA-20

2.4 V to 3.6 V Supply voltage :

^{*:} Character background color (color code) = "0" is transparent (displays lower-layer color).

■ PIN ASSIGNMENTS



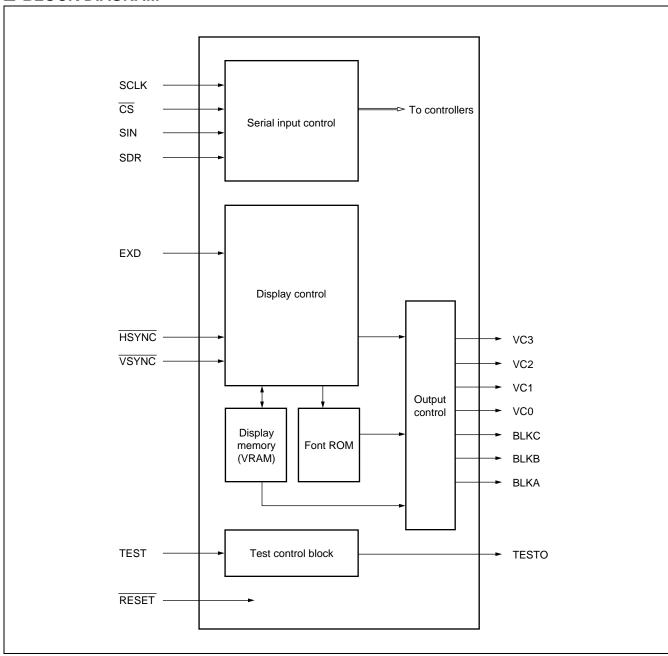
■ PIN DESCRIPTIONS

Pin	no.	Pin name	I/O	Circuit	Function
SSOP	FLGA	Pin name	1/0	type	Function
1	А3	SCLK	I	А	Shift clock input pin for serial transfer. This pin has an internal pull-up resistor.
2	A2	CS	I	А	Chip select pin. Input a low level signal during serial transfer. This pin has an internal pull-up resistor.
3	B1	SIN	I	Α	Serial data input pin. This pin has an internal pull-up resistor.
4	C1	RESET	I	В	Reset input pin. Input a low level signal at power-on time.
5	D1	V _{DD}			+3 V power supply pin.
6	E1	SDR	I	С	Data input direction select pin for serial transfer. Input a low level signal at LSB-first transfer mode, or a high level signal at MSB-first transfer mode.
7	F1	N.C.			Not connected. This pin should be left open.
8	G1	EXD	I	В	Display dot clock input pin.
9	H2	TEST	I	С	LSI test input pin. Input a low level signal during normal use.
10	НЗ	GND			Ground pin.
11	H4	BLKC	0	D	Display period signal output pin for output channel C.
12	H5	TESTO	0	D	LSI test output pin. This pin should be left open during normal use.
13	G6	BLKB	0	D	Display period signal output pin for output channel B.
15	E6	BLKA	0	D	Display period signal output pin for output channel A.
14 16 17 18	F6 D6 C6 B6	VC3 VC2 VC1 VC0	0 0 0	D	Color code signal output pins.
19	A5	VSYNC	l	В	Vertical synchronization signal input pin.
20	A4	HSYNC	Ī	В	Horizontal synchronization signal input pin.

■ I/O CIRCUIT TYPES

Туре	Circuit	Remarks
А		CMOS level, hysteresis input, pullup resistance (25 k Ω to 200 k Ω) .
В		CMOS level, hysteresis input.
С		CMOS level input.
D	Output	CMOS level output.

■ BLOCK DIAGRAM



■ COMPONENT ELEMENTS

- Serial input control block
 - Receives serial commands and data. Decodes commands, and allocates commands and data to the appropriate control blocks.
- · Display control block
 - Performs display control functions synchronized with the input sync signals.
- Display memory (VRAM) block VRAM memory for character data (24 bits \times 28 characters \times 12 lines) and line data (24 bits \times 12 lines) .
- Font ROM block
 - ROM memory for display character fonts. Configured for 1,024 characters of 12 dots \times 18 dots.
- Output control block
 - Generates output signals by applying display processing to the font data read from the font ROM.
- Test control block
 - Circuits for factory testing of the LSI before delivery.

■ ABSOLUTE MAXIMUM RATINGS

 $(V_{GND} = 0 V)$

Parameter	Symbol	Rat	ing	Unit	Remarks
Farameter	Syllibol	Min.	Max.	Onit	Remarks
Power supply voltage	V _{DD}	$V_{\text{GND}}-0.5$	V _{GND} + 4.0	V	
Input voltage	Vin	V _{GND} - 0.5	V _{DD} + 0.5	V	
Output voltage	Vouт	V _{GND} - 0.5	V _{DD} + 0.5	V	
Power consumption	Pd		100	mW	
Operating temperature	Та	-20	+70	°C	
Storage temperature	Tstg	-55	+150	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

 $(V_{GND} = 0 V)$

Parameter	Symbol	Va	lue	Unit	Remarks
Faranietei	Syllibol	Min.	Max.	Oille	Remarks
Power supply voltage	V _{DD}	2.4	3.6	V	
"H" level input voltage 1	Vihs	$0.8 \times V_{DD}$	V _{DD} + 0.3	V	*1
"L" level input voltage 1	VILS	V _{GND}	0.2 × V _{DD}	V	*1
"H" level input voltage 2	ViH	$0.7 \times V_{DD}$	V _{DD} + 0.3	V	*2
"L" level input voltage 2	VIL	V _{GND}	$0.3 \times V_{DD}$	V	*2
Operating temperature	Та	-20	+70	°C	

^{*1:} Input pins excluding TEST and SDR pins.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

> Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

> No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

^{*2:} TEST and SDR input pins.

■ ELECTRICAL CHARACTERISTICS

1. DC Characteristics

 $(V_{GND} = 0 \text{ V}, \text{ Ta} = -20 \text{ }^{\circ}\text{C to } +70 \text{ }^{\circ}\text{C})$

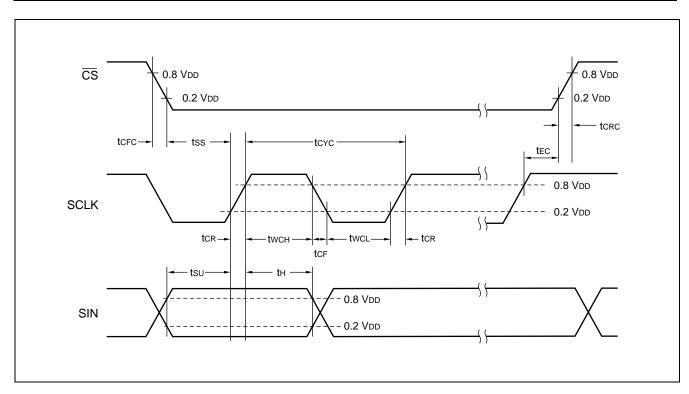
Parameter	Sym-	Pin name	Conditions		Value		Unit
Faranietei	bol	Finitianie	Conditions	Min.	Тур.	Max.	Onne
"H" level output voltage	Vон	VC3, VC2, VC1, VC0,	$V_{DD} = 3.3 \text{ V}$ $I_{OH} = -4 \text{ mA}$	V _{DD} - 0.5		V _{DD}	V
"L" level output voltage	Vol	BLKC, BLKB, BLKA	$V_{DD} = 3.3 \text{ V}$ $I_{OL} = 4 \text{ mA}$	Vgnd	_	0.4	V
"H" level input current	Іін	SDR, HSYNC, VSYNC,	$\begin{array}{c} V_{DD} = 3.3 \ V \\ V_{IH} = V_{DD} \end{array}$	_	_	+10	μА
"L" level input current	IIL	EXD, TEST, RESET	V _{DD} = 3.3 V V _{IL} = 0 V	_	_	-10	μА
Pull-up resistance	Rpull	SIN, SCLK, CS	$V_{DD} = 3.3 \text{ V}$	25	50	200	kΩ
Power supply current	Icc	V _{DD}	$V_{DD} = 2.4 \text{ V}$ $f_{DC} = 8 \text{ MHz}$	_	_	5	mA
Fower supply current	ICC	טט ע	$V_{DD} = 3.6 \text{ V}$ $f_{DC} = 8 \text{ MHz}$	_	_	6	mA
Input capacitance	С	Except VDD, GND	_			16	pF

2. AC Characteristics

(1) Serial input timings

(VDD = 2.4 V to 3.6 V, VGND = 0 V, Ta = -20 °C to +70 °C)

Parameter	Symbol	Pin name	Val	lue	Unit
Farameter	Syllibol	Pili liaille	Min.	Max.	Offic
Shift clock cycle time	t cyc	SCLK	250		ns
Shift clock pulse width	twcн	SCLK	100	_	ns
Shift clock pulse width	twcL	SOLK	100		ns
Shift clock signal rise/fall time Shift clock start time	t cr	SCLK		200	ns
	t CF	SOLK	_	200	ns
Shift clock start time	tss	SCLK	100		ns
Data setup time	t su	SIN	100	_	ns
Data hold time	tн	SIN	50		ns
Chip select end time	t EC	CS	100		ns
Chip select signal rise/fall time	tcrc	- CS		200	ns
Chip select signal fise/fall time	t cFC		_	200	ns

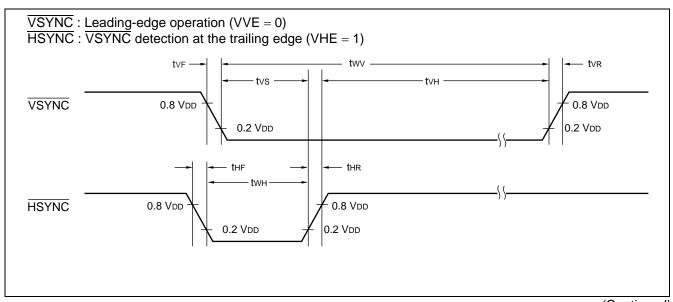


(2) Vertical and horizontal sync signal input timing

Parameter	Symbol	Pin name	Val	ue	Unit	
Farameter	Symbol	riii iiaiiie	Min.	Max.	Onit	
Horizontal sync signal rise time	t HR	HSYNC	_	200	ns	
Horizontal sync signal fall time	thf	HOTING	_	200	ns	
Vertical sync signal rise time	tvr	VSYNC	_	200	ns	
Vertical sync signal fall time	t∨F	VOTING	_	200	ns	
Horizontal sync signal pulse width *1	t wн	HSYNC	18	_	Dot clock	
Fiorizoniai sync signai puise widin		TISTING	_	6	μS	
Vertical sync signal setup time1 *2 (Except for VVE = 1, VHE = 1, HE = 1) *3	tvs	VSYNC	4	1H – 4	Dot clock	
Vertical sync signal setup time2 *2 (VVE = 1, VHE = 1, HE = 1) *3	tvs	VSYNC	- 6	1H – 14	Dot clock	
Vertical sync signal detection hold time	tvн	VSYNC	2		Н	
Vertical sync signal pulse width	twv	VSYNC	2	20	Н	

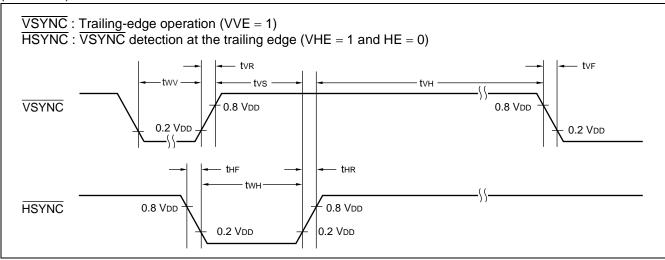
^{*1 :} During the horizontal sync signal pulse period, the MB90099 stops its internal operation, disabling writing to the internal VRAM. Therefore, the horizontal sync signal pulse width and VRAM write cycle (command 2 or command 4 issuance cycle) should be set so that the horizontal sync signal pulse width is shorter than the VRAM write cycle.

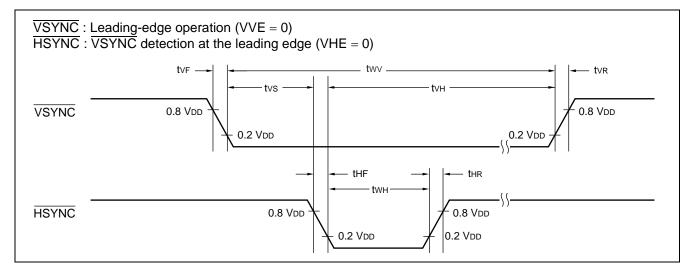
- *2 : In the vertical sync signal detection cycle, do not change the vertical sync signal (detection edge) when it is close to the horizontal sync signal edge. This may result in distortion of the display due to fluctuations in the sync signal.
- *3: VVE, VHE and HE are control bits of Command 13-0 (I/O pin control).

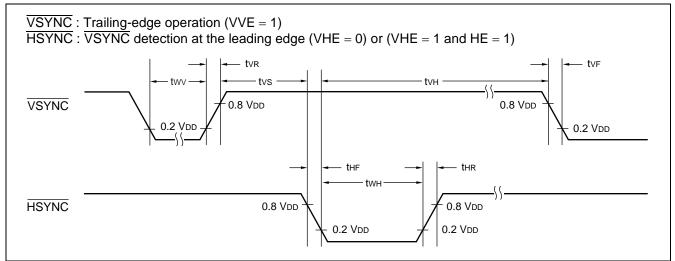


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Note: The above diagrams assume that I/O pin control command (command 13-0) has set the sync signal input logic control setting (SIX bit) to negative logic ("0"). However, if the positive logic setting (SIX bit = "1")□ is used, the H and L levels are reversed.

(3) Dot clock external input timing

 $(V_{DD} = 2.7 \text{ V to } 3.3 \text{ V}, V_{GND} = 0 \text{ V}, Ta = -20 ^{\circ}\text{C to } +70 ^{\circ}\text{C})$

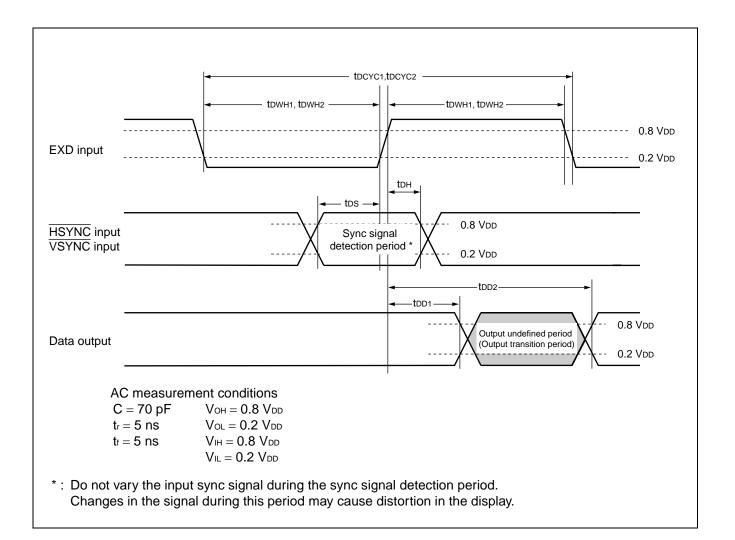
Parameter	Symbol	Pin name	Va	lue	Unit	Note	
raiailletei	Syllibol	Fili lialile	Min.	Max.	Oilit	Note	
Dot clock cycle time	tDCYC1	EXD	112	166	ns	*1	
Dot clock cycle time	tDCYC2	EXD	56	83	ns	*2	
	t DWH1	EXD	48		ns	- *1	
Dot clock pulse time	t DWL1	LAD	48		ns		
Dot clock pulse time	t DWH2	EXD	24		ns	*2	
	t _{DWL2}	LAD	24		ns	7 4	
HSYNC, VSYNC setup time	t DS	HSYNC,	13		ns	*3	
HSYNC, VSYNC hold time	tон	VSYNC	0		ns	*3	
Data output delay time 1	Data output delay time 1 toD1		7	t DD2	ns	*3	
Data output delay time 2	t DD2	BLKA, BLKB, BLKC	t DD1	45	ns] 3	

Note : The above items assume a supply voltage of $V_{DD} = 2.7 \text{ V}$ to 3.3 V.

^{*1 :} Assuming input frequency = dot clock \times 1.

^{*2 :} Assuming input frequency = dot clock \times 2.

^{*3 :} Assuming input frequency = dot clock \times 1 or dot clock \times 2.

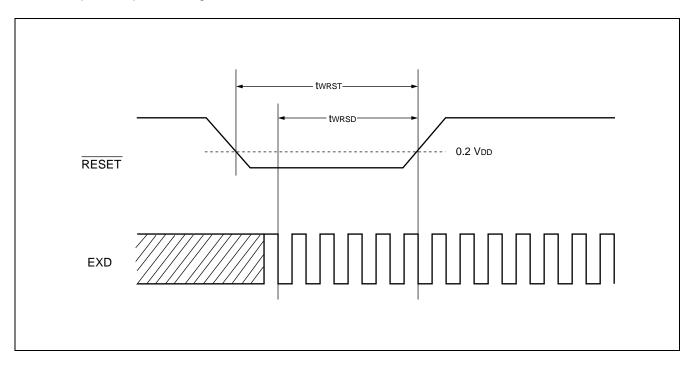


(4) Reset input timing

(V_{DD} = 2.4 V to 3.6 V, V_{GND} = 0 V, Ta = -20 °C to +70 °C)

Parameter	Symbol	Pin name	Va	lue	Unit	Note
Faranietei	Syllibol	Fill Hallie	Min.	Max.	Offic	Note
Reset pulse width	t wrst	RESET	1	_	μS	
Clock input	twrsd	EXD	5		Dot clock	*

^{*:} Clock input is required during reset.



■ DISPLAY CONTROL COMMANDS

1. Command list

Com-	Frantian					Со	mman	d cod	e/data	l				
mand no.	Function	15 to 12	11	10	9	8	7	6	5	4	3	2	1	0
0	VRAM write address setting	0000	AY3	AY2	AY1	AY0	FL	0	0	AX4	AX3	AX2	AX1	AX0
1	Character data setting 1	0001	MO1	MO0	MM1	MM0	MB3	MB2	MB1	MB0	МС3	MC2	MC1	MC0
2	Character data setting 2	0010	MR	MS	M9	M8	M7	M6	M5	M4	МЗ	M2	M1	МО
3	Line control data setting 1	0011	LHS	LW2	LW1	LW0	LFD	LFC	LFB	LFA	LF3	LF2	LF1	LF0
4	Line control data setting 2	0100	LDS	LGS	LG1	LG0	LD	LE	LM1	LM0	L3	L2	L1	L0
5-00	Screen output control 1A	0101	0	0	0	0	SDS	UDS	0	DSP	0	OA2	OA1	OA0
5-01	Screen output control 1B	0101	0	0	0	1	SOB	BGB	BLB	0	0	OB2	OB1	ОВ0
5-02	Screen output control 1C	0101	0	0	1	0	SOC	BGC	BLC	0	0	OC2	OC1	OC0
5-2	Vertical display position control	0101	1	0	0	Y8	Y7	Y6	Y5	Y4	Y3	Y2	Y1	Y0
5-3	Horizontal display position control	0101	1	1	0	X8	X7	X6	X5	X4	Х3	X2	X1	X0
6-1	Shaded background frame color control	0110	0	1	0	0	ВН3	BH2	BH1	ВН0	BS3	BS2	BS1	BS0
7-3	Screen background control	0111	1	1	0	0	0	0	0	0	U3	U2	U1	U0
8-0	Sprite character control 1	1000	0	0	SFB	SFA	SF3	SF2	SF1	SF0	SC3	SC2	SC1	SC0
8-1	Sprite character control 2	1000	0	1	SD1	SD0	SM7	SM6	SM5	SM4	SM3	SM2	SM1	SM0
9-0	Sprite character control 4	1001	0	0	SY9	SY8	SY7	SY6	SY5	SY4	SY3	SY2	SY1	SY0
9-1	Sprite character control 5	1001	1	0	SX9	SX8	SX7	SX6	SX5	SX4	SX3	SX2	SX1	SX0
11-0	Screen extension control	1011	0	0	0	0	0	EG0	0	0	0	0	0	0
11-2	Dot clock control 1	1011	1	0	0	0	0	0	0	0	0	DC2	DC1	DC0

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Com- mand no.	Function	Command code/data												
		15 to 12	11	10	9	8	7	6	5	4	3	2	1	0
13-0	I/O pin control	1101	0	0	VVE	VHE	HE	0	SIX	0	0	0	DBX	DCX
13-1	Horizontal blanking control 1	1101	0	1	0	0	0	0	BB5	BB4	BB3	BB2	BB1	BB0
13-2	Horizontal blanking control 2	1101	1	0	0	BF8	BF7	BF6	BF5	BF4	BF3	BF2	BF1	BF0

2. Command Description

• Command 0 (VRAM write address setting)

Command 0 sets the write address in VRAM, and controls the execution of "VRAM fill". The write address is specified by row and column addresses. VRAM fill is activated by executing character data setting 2 (command 2).

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
0	0	0	0	AY3	AY2	AY1	AY0	FL	0	0	AX4	AX3	AX2	AX1	AX0	l

AY3 to AY0: Row address (0 to B_H)

AX4 to AX0 : Column address (0 to 1B_H)

FL: VRAM Fill control (0: OFF, 1: ON)

• Command 1 (Character data setting 1)

Command 1 specifies character data. The character data is written to VRAM and reflected on the screen by the execution of command 2 (character data setting 2).

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	_
0	0	0	1	MO1	MO0	MM1	ММО	MB3	MB2	MB1	МВ0	МС3	MC2	MC1	MC0	

MO1, MO0: Character output control

MM1, MM0: Character background control

(0, 0 : Off) (0, 1 : Solid fill)

(1, 0 : Concaved shaded)

(1, 1: Convexed shaded)

MC3 to MC0 : Character color (16 colors)

MB3 to MB0: Background color (16 colors)

• Command 2 (Character data setting 2)

Command 2 writes additional character data to the location in VRAM spacified by command 0 (VRAM write address setting), along with the character data set by command 1 (character data setting 1).

The VRAM write address is automatically incremented after command 2 is executed.

_	15	14	13	12	11	10	9	8	/	6	5	4	3	2	1	0
	0	0	1	0	MR	MS	М9	M8	M7	M6	M5	M4	МЗ	M2	M1	M0

MR: Shaded background succeeding character merge control

(0 : Not merged with succeeding character)

(1 : Merged with succeeding character)

MS: Character horizontal size control

(0 : S size, 6 dots) (1 : L size, 12 dots)

M9 to M0: Character code

• Command 3 (Line control data setting 1)

Command 3 specifies line control data. The line control data is written to VRAM and reflected on the screen by the execution of command 4 (line control data setting 2).

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	1	1	LHS	LW2	LW1	LW0	LFD	LFC	LFB	LFA	LF3	LF2	LF1	LF0

LHS: Line character vertical size type control

(0 : Character vertical size A)

(1 : Character vertical size B)

LW2 to LW0 : Line spacing control

(0 to 7 dots, in 1-dot units)

LF3 to LF0: Trimming color (16 colors)

LFD, LFC: Trimming output control

(0, 0 : All Off)

(0, 1: Trimming On for a character only, no character background)

(1, 0 : Trimming On for a solid-fill character or no character background)

(1, 1 : All On)

LFB, LFA: Trimming control

(0, 0: Trimming Off)

(0, 1: Reserved (setting prohibited))

(1, 0: Reserved (setting prohibited))

(1, 1 : Eight-direction trimming)

• Command 4 (Line control data setting 2)

Command 4 specifies additional line control data and writes this data, along with the line control data set by command 3 (line control data setting 1) to the row address in VRAM specified by command 0 (VRAM write address setting).

Executing this command will not alter the VRAM write address.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	LDS	LGS	LG1	LG0	LD	LE	LM1	LM0	L3	L2	L1	LO

LDS: Line character output control (control of a character + trimming + character background)

(0: Off, 1: On)

LGS: Line enlargement interpolation control

(0: Off, 1: On)

LG1, LG0: Line enlargement control

(0, 0 : Normal)

(0, 1 : Double width)

(1, 0 : Double height)

 $(1, 1 : Double width \times double height)$

LE: Character background extension control

(0 : Normal, 1 : Extended)

LD: Shaded background succeeding line merge control

(0: Independent)

(1 : Merged with succeeding line)

LM1, LM0: Line background control

(0, 0 : Off)

(0, 1 : Solid fill)

(1, 0 : Concaved shaded)

(1, 1 : Convexed shaded)

L3 to L0: Line background color (16 colors)

• Command 5-00 (Screen output control 1A)

Command 5-00 controls screen display output.

_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	0	1	0	1	0	0	0	0	SDS	UDS	0	DSP	0	OA2	OA1	OA0

SDS: Sprite character output control

(0: Off, 1: On) *

UDS: Screen background output control

(0: Off, 1: On) *

DSP: Display output control (Control of a character + trimming + character background + line background)

(0: Off, 1: On) *

OA2 to OA0: Output-A character control (8 types)

• Command 5-01 (Screen output control 1B)

Command 5-01 controls output-B screen display output.

_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	0	1	0	1	0	0	0	1	SOB	BGB	BLB	0	0	OB2	OB1	ОВ0

SOB: Output-B sprite character output control

(0: Off, 1: On)

BGB: Output-B screen background output control

(0: Off, 1: On)

BLB: Output-B line background output control

(0: Off, 1: On)

OB2 to OB0 : Output-B character control (8 types)

^{*:} Input of an 'L' level signal to the RESET pin will initialize SDS = 0, UDS = 0, and DSP = 0.

• Command 5-02 (Screen output control 1C)

Command 5-02 controls output-C screen display output.

_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	0	1	0	1	0	0	1	0	soc	BGC	BLC	0	0	OC2	OC1	OC0

SOC: Output-C sprite character output control

(0: Off, 1: On)

BGC: Output-C screen background output control

(0: Off, 1: On)

BLC: Output-C line background output control

(0: Off, 1: On)

OC2 to OC0 : Output-C character control (8 types)

• Command 5-2 (Vertical display position control)

Command 5-2 controls the vertical display position on the screen.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	1	1	0	0	Y8	Y7	Y6	Y5	Y4	Y3	Y2	Y1	Y0

Y8 to Y0: Vertical display position control (0 to 1022 in 2-dot units)

• Command 5-3 (Horizontal display position control)

Command 5-3 controls the horizontal display position on the screen.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	1	1	1	0	X8	Х7	X6	X5	X4	Х3	X2	X1	X0

X8 to X0: Horizontal display position control (0 to 1022 in 2-dot units)

• Command 6-1 (Shaded background frame color control)

Command 6-1 controls the frame color of the shaded background.

_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	0	1	1	0	0	1	0	0	ВН3	BH2	BH1	ВН0	BS3	BS2	BS1	BS0

BH3 to BH0: Shaded background frame highlight color (16 colors)

BS3 to BS0 : Shaded background frame shadow color (16 colors)

Command 7-3 (Screen background control)

Command 7-3 controls the screen background color.

_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	0	1	1	1	1	1	0	0	0	0	0	0	U3	U2	U1	U0

U3 to U0: Screen background color (16 colors)

• Command 8-0 (Sprite character control 1)

Command 8-0 controls sprite characters.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	_
1	0	0	0	0	0	SFB	SFA	SF3	SF2	SF1	SF0	SC3	SC2	SC1	SC0	

SFB, SFA: Sprite character trimming control

(0, 0 : Trimming Off) (0, 1 : Reserved) (1, 0 : Reserved)

(1, 1: Eight-direction trimming)

SF3 to SF0: Sprite character trimming color (16 colors)

SC3 to SC0: Sprite character color (16 colors)

• Command 8-1 (Sprite character control 2)

Command 8-1 controls sprite characters.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	0	0	0	1	SD1	SD0	SM7	SM6	SM5	SM4	SM3	SM2	SM1	SM0

SD1, SD0: Sprite character configuration control

(0, 0 : 1 character)

(0, 1: Reserved (setting prohibited))

(1, 0: Stack of 2 characters)

(1, 1: Reserved (setting prohibited))

SM7 to SM0 : Sprite character code

(000H to 0FFH for 256 different characters)

• Command 9-0 (Sprite character control 4)

Command 9-0 controls the vertical display position of sprite characters.

						9									
1	0	0	1	0	0	SY9	SY8	SY7	SY6	SY5	SY4	SY3	SY2	SY1	SY0

SY9 to SY0: Sprite character vertical display position control

(0 to 1023 in 1-dot units)

• Command 9-1 (Sprite character control 5)

Command 9-1 controls the horizontal display position of sprite characters.

_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	1	0	0	1	1	0	SX9	SX8	SX7	SX6	SX5	SX4	SX3	SX2	SX1	SX0

SX9 to SX0 : Sprite character horizontal display position control

(0 to 1023 in 1-dot units)

• Command 11-0 (Screen extension control)

(Reserved)

															0
1	0	1	1	0	0	0	0	0	EG0	0	0	0	0	0	0

EG0: (Reserved) (0: Normal)

(1: Reserved (setting prohibited))

• Command 11-2 (Dot clock control 1)

Command 11-2 controls dot clock selection.

_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	1	0	1	1	1	0	0	0	0	0	0	0	0	DC2	DC1	DC0

DC2 to DC0 : Dot clock selection control (0, 1, 0) : External dot clock input

(0, 1, 1): Frequency-doubled external dot clock input

• Command 13-0 (I/O pin control)

Command 13-0 controls I/O pin functions.

							8								
1	1	0	1	0	0	VVE	VHE	HE	0	SIX	0	0	0	DBX	DCX

VVE: Edge selection for vertical synchronization detection*1

(0 : Leading edge, 1 : Trailing edge)

VHE: HSYNC edge selection for vertical synchronization detection*1

(0 : Leading edge, 1 : Trailing edge)

HE: Edge selection for horizontal synchronization operation*1

(0 : Trailing edge, 1 : Leading edge)

SIX: Logic control for sync signal input

(0 : Negative logic, 1 : Positive logic)

DCX: Logic control for display color signal output

(0 : Positive logic, 1 : Negative logic) *2

DBX: Logic control for display output period signal

(0 : Positive logic, 1 : Negative logic) *2

*1 : When it is set up VVE = 1, VHE = 1 and HE = 1, the vertical sync detection	HSYNC edge is the standard of
"Leading edge".	

VVE	VHE	HE	Contents of vertical sync detection	Position of vertical sync detection*
0	0	0	Detection of VSYNC Leading edge	HSYNC Leading edge
0	0	1	Detection of VSYNC Leading edge	HSYNC Leading edge
0	1	0	Detection of VSYNC Leading edge	HSYNC Trailing edge
0	1	1	Detection of VSYNC Leading edge	HSYNC Trailing edge
1	0	0	Detection of VSYNC Trailing edge	HSYNC Leading edge
1	0	1	Detection of VSYNC Trailing edge	HSYNC Leading edge
1	1	0	Detection of VSYNC Trailing edge	HSYNC Trailing edge
1	1	1	Detection of VSYNC Trailing edge	HSYNC Leading edge + 10 clock

^{*:} If there is the change of level for direction of VSYNC pin signal detection in the vicinity of vertical sync detection, it may occur disorder in the display (deflection of vertical direction). Input the meaningful edge of VSYNC signal without this position of vertical sync detection.

• Command 13-1 (Horizontal blanking control 1)

Command 13-1 controls the back porch of the horizontal blanking function.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	1	0	1	0	0	0	0	BB5	BB4	BB3	BB2	BB1	BB0

BB5 to BB0 : Back porch control (0 to 126, in 2-dot units)

• Command 13-2 (Horizontal blanking control 2)

Command 13-2 controls the front porch of the horizontal blanking function.

_						10										
	1	1	0	1	1	0	0	BF8	BF7	BF6	BF5	BF4	BF3	BF2	BF1	BF0

BF8 to BF0: Front porch control (0 to 1022, in 2-dot units)

^{*2 :} Input of an 'L' level signal to the \overline{RESET} pin will initialize DCX = 0, and DBX = 0.

3. Notes on Issuing Commands

(1) Initialization

When a reset signal is input ("L" level signal input to the RESET pin), the MB90099 enters display-off state(*). The contents of VRAM (the character RAM and the line RAM) are undefined.

Immediately after release of the input signal to the MB90099, issue the following commands to initialize control operation.

- Dot clock control 1 (command 11-2)
- I/O pin control (command 13-0)

This must be done before setting all command data and all RAM contents. (VRAM settings require normal dot clock input and normal sync signal input.)

*: The reset input initializes control bits as follows.

Screen output control 1A (command 5-00)

SDS = 0 Sprite Off

UDS = 0 Screen background Off

DSP = 0 Character, character background, line background Off

I/O pin control (command 13-0)

DCX = 0 VC0, VC1, VC2, VC3 pins set to positive logic output

DBX = 0 BLKA, BLKB, BLKC pins set to positive logic output

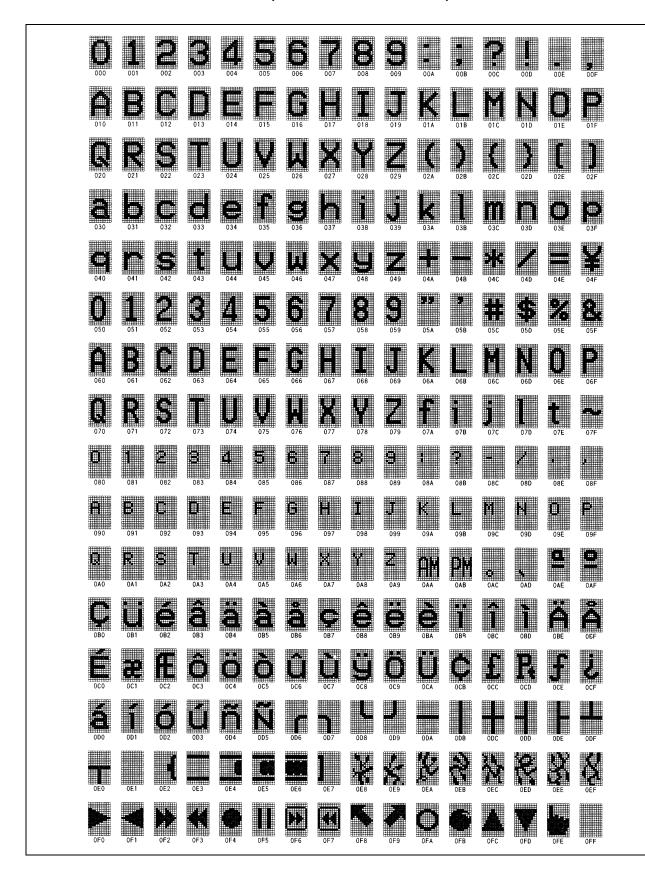
(2) Command refresh

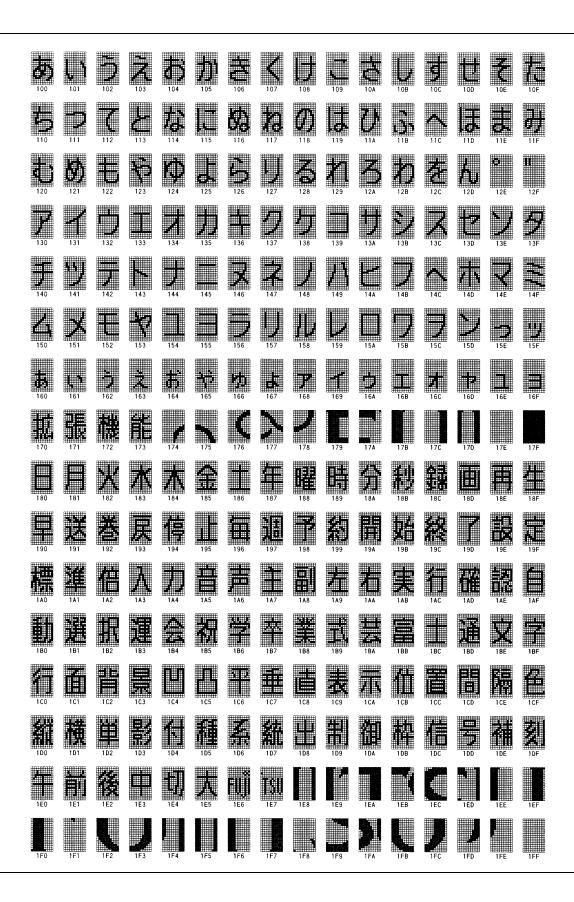
Command data to the MB90099 and the contents of internal VRAM are stored as long as power is supplied to the MB90099. However, there may be cases in which the serial control, sync, or dot clock signals become abnormal due to causes such as external noise, preventing the internal registers and VRAM from being set properly. It is therefore recommended that all command data and VRAM data be refreshed periodically to ensure that this data is correct.

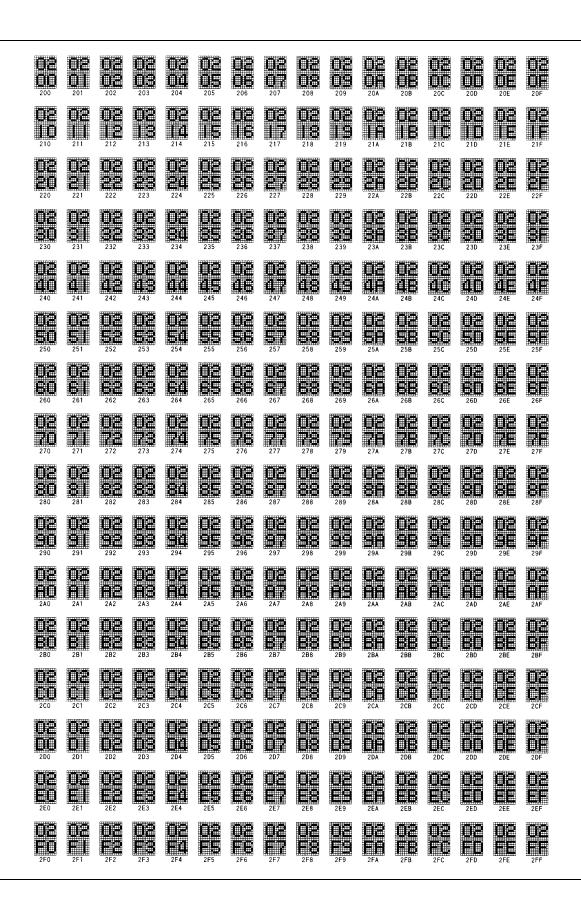
(3) Command issue timing

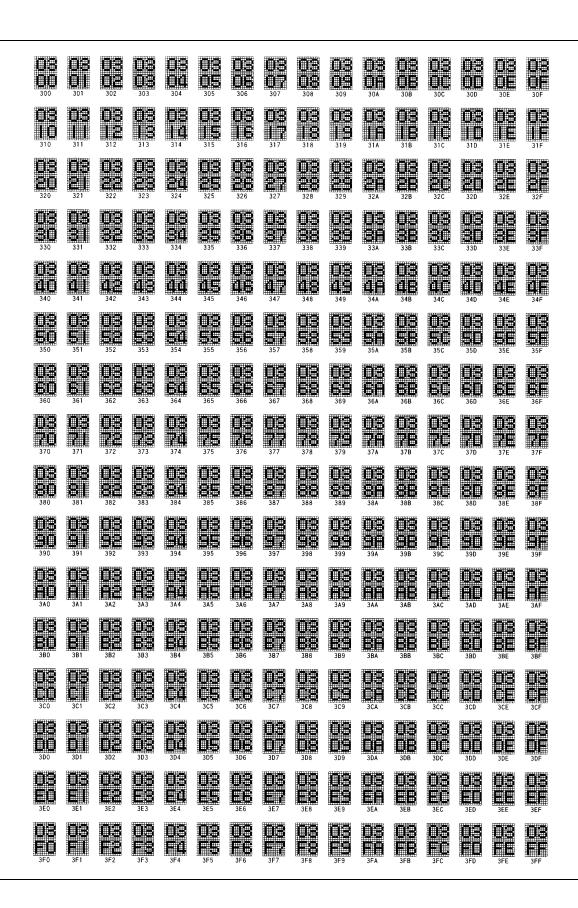
When any control command, including a VRAM write command such as a character data setting or line control data setting command is issued, the command is executed immediately and the result is reflected on the screen. When such a command is issued during a display period, the display in the relevant field may experience momentary distortion. To avoid this, it is recommended that commands be issued during the vertical blanking interval. However that with a command 5-00 (screen output control 1A) in which one or more of the DSP, SDS, or UDS control bits is switched from OFF to ON, the display will wait until the next vertical sync signal after the command is issued and the display will start from the top of the scanning field.

■ CONTENTS OF MB90099-001 (STANDARD PRODUCT) FONT DATA





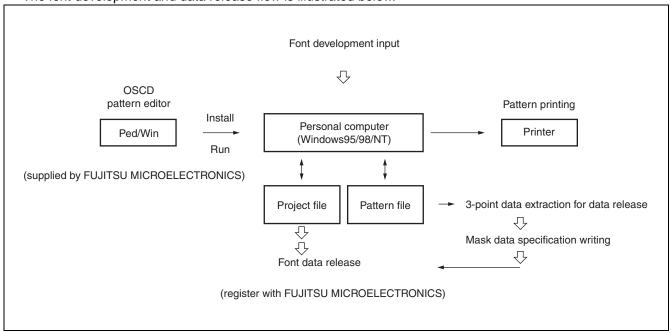




■ FONT DEVELOPMENT AND DATA RELEASE

The MB90099 features the font ROM in which all 1024 characters are user-definable. For font data development, use the OSDC pattern editor Ped/Win. Ped/Win is an OSCD proprietary pattern editor for use on personal computers operating Windows95/98/NT4.0 (Japanese language) environments.

The font development and data release flow is illustrated below.



(1) Font data release

Font data is released in project files only. Pattern files should not be released. A portion of the pattern file data will be used for data matching in order to verify registration of release data by FUJITSU MICROELECTRONICS. For this reason, users are requested to write a portion of the pattern data content in mask data specifications.

Note: Pattern data output should not be generated until after the completion of font creation and project creation. Also, the project file should not be updated after pattern file generation is completed. If the project contents are updated after pattern file generation, pattern files should be generated again.

(2) Project files

After font data and other supplementary data is created, it is stored in a project file. Normally one project file is created for each model.

Project file names

Project file names should be in the format "MB90099-XXX" where "XXX" is a ROM number assigned by FUJITSU MICROELECTRONICS. Users should contact their FUJITSU MICROELECTRONICS sales representative. If no ROM number has been assigned, any number preceded by an alphabetic character may be used. Project files which are developed solely for test purposes and not intended for font release may be assigned any file name.

· Comments related to new project files

Comment lines in the form of any desired character strings may be added at the time a project file is created. Comments will be printed when the font is printed, and can be modified as needed whenever that Ped/Win is operating.

(3) Pattern files

Font data may be placed in pattern files. Because pattern data is saved in the project file, normally it is only necessary to create a pattern file at the time of font release for the purpose of extracting verification data (writing to mask data specifications). Pattern files should not be released.

· Pattern file loading

Pattern files can be loaded for some OSCD models other than the MB90099.

Pattern file output generation

Do not create more than one pattern file for the same project. This may cause errors . In such cases, the project name should be altered to create another project.

· Extracting verification data

Three data points, the first and last addresses and one other random address, should be extracted from pattern file data and written into the mask data specifications. The random address should not include the data values "00" or "FF."

Note: Ped/Win display functions are based on OSDC specifications, however some display specifications may not be identical to actual OSDC specifications. Users should consult specification documents for details.

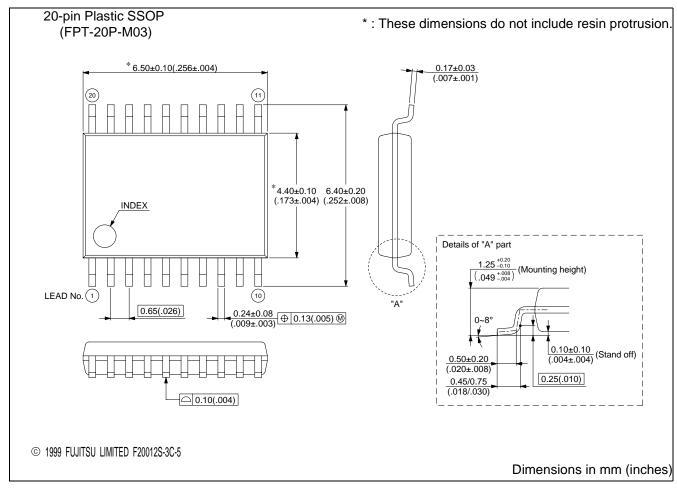
(Data comparison)

After data release, once ROM mask processing is completed FUJITSU MICROELECTRONICS will extract the ROM data used in this process. Users should verify that the extracted data is identical to the pattern file data that was submitted, and return a written statement of data comparison indicating whether that data is identical or not . If the data is not identical, contact FUJITSU MICROELECTRONICS's sales representative immediately. Data errors may cause errors in ES production.

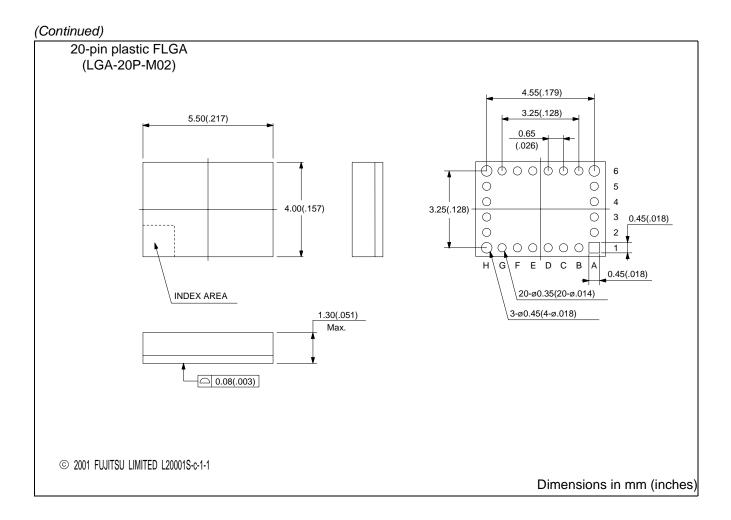
■ ORDERING INFORMATION

Part Number	Package	Remarks
MB90099PFV	20-pin Plastic SSOP (FPT-20P-M03)	
MB90099LGA	20-pin Plastic FLGA (LGA-20P-M01)	

■ PACKAGE DIMENSION



(Continued)



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